

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4360070

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the STATE/COUNTRY: JAMAICA - SHOULD BE STATE/COUNTRY: JAPAN previously recorded on Reel 040470 Frame 0445. Assignor(s) hereby confirms the STATE/COUNTRY: JAMAICA - SHOULD BE STATE/COUNTRY: JAPAN.
RESUBMIT DOCUMENT ID:	504253251

CONVEYING PARTY DATA

Name	Execution Date
YASUHIRO ITAGAKI	08/22/2016
SHIGEKAZU ITO	08/22/2016

RECEIVING PARTY DATA

Name:	RIKEN TECHNOS CORPORATION
Street Address:	2-101, KANDA-AWAJICHO, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15315267

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	000425.101110 (RIKE110)
NAME OF SUBMITTER:	ESMERALDA MENDOZA
SIGNATURE:	/Brad Y. Chin/
DATE SIGNED:	04/10/2017

Total Attachments: 6

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YASUHIRO ITAGAKI	08/22/2016
SHIGEKAZU ITO	08/22/2016
RECEIVING PARTY DATA	
Name:	RIKEN TECHNOS CORPORATION
Street Address:	2-101, KANDA-AWAJICHO, CHIYODA-KU
City:	TOKYO
State/Country:	TAMAICA JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
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Correspondent Name:	BRACEWELL LLP
Address Line 1:	P.O. BOX 61389
Address Line 4:	HOUSTON, TEXAS 77208-1389
ATTORNEY DOCKET NUMBER:	000425.101110 (RIKE110)
NAME OF SUBMITTER:	ESMERALDA MENDOZA
Signature:	/Brad Y. Chin/
Date:	11/30/2016
Total Attachments: 3	
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PATENT
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RECEIPT INFORMATION

EPAS ID: PAT4163727

Receipt Date: 11/30/2016

W7231-09

Docket No. 000425.101110

(RIKE110)

ASSIGNMENT

WHEREAS, we, **Yasuhiro ITAGAKI** and **Shigekazu ITO** are inventors of "ACTINIC-RAY-CURABLE RESIN COMPOSITION, LAYERED FILM INCLUDING HARDCOAT FORMED THEREFROM, AND LAYERED TRANSPARENT RESIN PRODUCT", for which application for United States Letters Patent was filed on November 30, 2016, as U.S. Application No. 15/315,267 (responsible attorney has authorization to fill in serial number and filing date upon filing); and

WHEREAS, **RIKEN TECHNOS CORPORATION**, whose post office address is 2-101, Kanda-Awajicho, Chiyoda-ku, Tokyo, Japan a corporation created and existing under and by virtue of the laws of Japan, is desirous of acquiring the entire right, title and interest in and to the aforesaid invention throughout the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all other countries throughout the world; and

NOW, THEREFORE, be it known by all whom it may concern that for and in consideration of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, we the inventors hereby sell, assign, transfer, and set over to **RIKEN TECHNOS CORPORATION**, all right, title and interest in and to the said invention throughout the entire world, in and to said application for U.S. Letters Patent, and any and all divisions, continuations, substitutions, continuations-in-part, and reissues thereof, and any and all Letters Patent of the United States and foreign countries which may be granted therefore on such inventions or improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States. The assignments and transfers described herein are to be held and enjoyed by **RIKEN TECHNOS CORPORATION** for its own use and benefit, and for the use and benefit of its successors, assigns, or other legal representatives, to the end of the term or terms for which said Letters Patent of the United States or foreign countries are or may be granted or reissued, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made. We further hereby assign and transfer to said corporation whatever cause of action we may have for past or present infringement of said invention, together with the right to bring suit for any such infringement and to seek and receive damages and other relief arising from any such infringement.

We the inventors do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said invention or resulting from said application and from any and all divisions, continuations, and reissues thereof, to **RIKEN TECHNOS CORPORATION**, as assignee of my entire interest, and hereby covenant that we have the full right to convey the entire interest herein assigned, and that we have not executed and will not execute any agreement in conflict herewith.

We the inventors do further hereby covenant and agree that we will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the

title of said invention and to such Letters Patent as may be granted therefore to **RIKEN TECHNOS CORPORATION**, its successors, assigns, or other legal representatives and that if **RIKEN TECHNOS CORPORATION**, its successors, assigns or other legal representatives shall desire to file any divisional or continuation applications or to secure a reissue of such Letters Patent, or to file a disclaimer relating thereto, will upon request, sign all papers, make all rightful oaths and do all lawful acts requisite for the filing of such divisional or continuation application, or such application for reissue and for the procuring thereof, and for the filing of such disclaimer, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

We the inventors do further covenant and agree that we will, at any time upon request, communicate to **RIKEN TECHNOS CORPORATION**, its successors, assigns or other legal representatives, such facts relating to said invention and Letters Patent or the file history thereof as maybe known to us, and testify as to the same in any interference or other litigation when requested so to do, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

EXECUTED THIS 22th day of August, 2016.

Yasuhiro ITAGAKI
Yasuhiro ITAGAKI

Nozomu Washio
WITNESS

Yasushi Hino
WITNESS

EXECUTED THIS 22th day of August, 2016, 2016.

Shigekazu ITO
Shigekazu ITO

Nozomu WASHIO
WITNESS

Jun FUJIMOTO
WITNESS